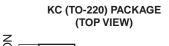
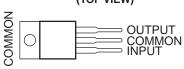
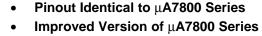


FEATURES

- ±1% Output Tolerance at 25°C
- ±2% Output Tolerance Over Full Operating Range
- Thermal Shutdown

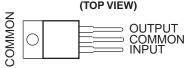


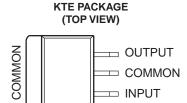


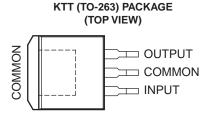


Internal Short-Circuit Current Limiting









DESCRIPTION/ORDERING INFORMATION

Each fixed-voltage precision regulator in the TL780 series is capable of supplying 1.5 A of load current. A unique temperature-compensation technique, coupled with an internally trimmed band-gap reference, has resulted in improved accuracy when compared to other three-terminal regulators. Advanced layout techniques provide excellent line, load, and thermal regulation. The internal current-limiting and thermal-shutdown features essentially make the devices immune to overload.

ORDERING INFORMATION

TJ	V _O TYP (V)	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING
		PowerFLEX™ – KTE	Reel of 2000	TL780-05CKTER	TL780-05C
	5	TO-220 – KC	Tube of 50	TL780-05CKC	TL780-05C
	5	TO-220, short shoulder – KCS	Tube of 20	TL780-05KCS	TL780-05
0°C to 125°C		TO-263 – KTT	Reel of 500	TL780-05CKTTR	TL780-05C
0.0 10 125.0	40	TO-220 – KC	Tube of 50	TL780-12CKC	TL780-12C
	12	TO-220, short shoulder – KCS	Tube of 20	TL780-12KCS	TL780-12
	15	TO-220 – KC	Tube of 50	TL780-15CKC	TL780-15C
		TO-220, short shoulder – KCS	Tube of 20	TL780-15KCS	TL780-15

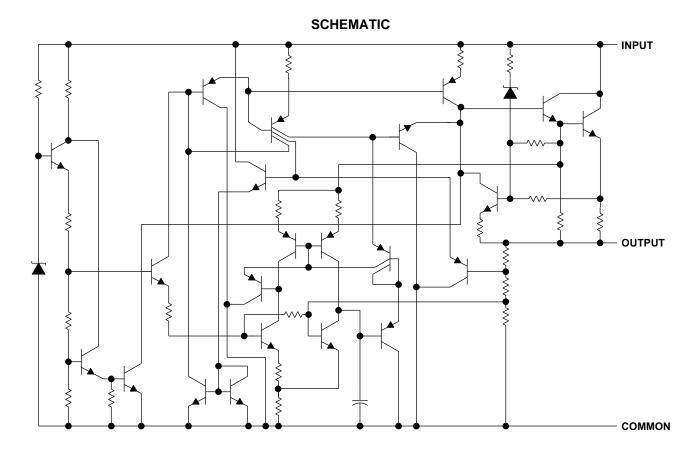
(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



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PowerFLEX, PowerPAD are trademarks of Texas Instruments.





Absolute Maximum Ratings(1)

over operating temperature ranges (unless otherwise noted)

		MIN	MAX	UNIT
V_{I}	Input voltage		35	V
T_J	Operating virtual junction temperature		150	°C
	Lead temperature 1,6 mm (1/16 in) from case for 10 s		260	°C
T _{stg}	Storage temperature range	-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

Package Thermal Data⁽¹⁾

PACKAGE	BOARD	θ _{JP} ⁽²⁾	θјс	θ_{JA}
PowerFLEX (KTE)	High K, JESD 51-5	2.7°C/W	11.6°C/W	23.3°C/W
TO-220 (KC/KCS)	High K, JESD 51-5	3°C/W	17°C/W	19°C/W
TO-263 (KTT)	High K, JESD 51-5	1.91°C/W	18°C/W	25.3°C/W

- (1) Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can affect reliability. Due to variations in individual device electrical characteristics and thermal resistance, the built-in thermal overload protection may be activated at power levels slightly above or below the rated dissipation.
- (2) For packages with exposed thermal pads, such as QFN, PowerPADTM, or PowerFLEX, θ_{JP} is defined as the thermal resistance between the die junction and the bottom of the exposed pad.



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Recommended Operating Conditions

			MIN	MAX	UNIT
		TL780-05C	7	25	
V_{I}	Input voltage	TL780-12C	14.5	30	V
		TL780-15C	17.5	30	
Io	Output current	·		1.5	Α
T_{J}	Operating virtual junction temperature		0	125	°C

Electrical Characteristics

at specified virtual junction temperature, V_{I} = 10 V, I_{O} = 500 mA (unless otherwise noted)

DADAMETED	TEST COMPITIONS	T (1)	T	L780-05C		LINUT	
PARAMETER	TEST CONDITIONS	T _J ⁽¹⁾	MIN	TYP	MAX	UNIT	
Output valtage	$I_{O} = 5 \text{ mA to 1 A, P} \le 15 \text{ W,}$	25°C	4.95	5	5.05	V	
Output voltage	$V_I = 7 \text{ V to } 20 \text{ V}$	0°C to 125°C	4.9		5.1	V	
Innut valtage regulation	V _I = 7 V to 25 V	3500		0.5	5	m\/	
Input voltage regulation	V _I = 8 V to 12 V	25°C		0.5	5	mV	
Ripple rejection	V _I = 8 V to 18 V, f = 120 Hz	0°C to 125°C	70	85		dB	
Output voltage regulation	$I_{O} = 5 \text{ mA to } 1.5 \text{ A}$	25°C		4	25	mV	
Output voltage regulation	$I_{O} = 250 \text{ mA to } 750 \text{ mA}$	25 C		1.5	15	111 V	
Output resistance	f = 1 kHz	0°C to 125°C		0.0035		Ω	
Temperature coefficient of output voltage	I _O = 5 mA	0°C to 125°C		0.25		mV/°C	
Output noise voltage	f = 10 Hz to 100 kHz	25°C		75		μV	
Dropout voltage	I _O = 1 A	25°C		2		V	
Input bias current		25°C		5	8	mA	
Input high gurrent change	V _I = 7 V to 25 V	0°C to 125°C		0.7	1.3	A	
Input bias-current change	I _O = 5 mA to 1 A	0°C to 125°C		0.003	0.5	mA	
Short-circuit output current		25°C		750		mA	
Peak output current		25°C		2.2		Α	

⁽¹⁾ Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.22-μF capacitor across the output.

TL780 SERIES POSITIVE-VOLTAGE REGULATORS

SLVS055M-APRIL 1981-REVISED OCTOBER 2006



Electrical Characteristics

at specified virtual junction temperature, $V_I = 19 \text{ V}$, $I_O = 500 \text{ mA}$ (unless otherwise noted)

DADAMETED	TEST COMPITIONS	T (1)	Т	L780-12C		LINUT	
PARAMETER	TEST CONDITIONS	T _J ⁽¹⁾	MIN	TYP	MAX	UNIT	
Output voltogo	$I_{O} = 5 \text{ mA to 1 A, P} \le 15 \text{ W,}$	25°C	11.88	12	12.12	V	
Output voltage	$V_1 = 14.5 \text{ V to } 27 \text{ V}$	0°C to 125°C	11.76		12.24	V	
Input voltage regulation	$V_I = 14.5 \text{ V to } 30 \text{ V}$	25°C		1.2	12	m\/	
Input voltage regulation	V _I = 16 V to 22 V	25 C		1.2	12	mV	
Ripple rejection	$V_I = 15 \text{ V to } 25 \text{ V}, f = 120 \text{ Hz}$	0°C to 125°C	65	80		dB	
Output valtage regulation	I _O = 5 mA to 1.5 A	2500		6.5	60	mV	
Output voltage regulation	$I_O = 250$ mA to 750 mA	25°C		2.5	36	IIIV	
Output resistance	f = 1 kHz	0°C to 125°C		0.0035		Ω	
Temperature coefficient of output voltage	I _O = 5 mA	0°C to 125°C		0.6		mV/°C	
Output noise voltage	f = 10 Hz to 100 kHz	25°C		180		μV	
Dropout voltage	I _O = 1 A	25°C		2		V	
Input bias current		25°C		5.5	8	mA	
land bing summed the same	V _I = 14.5 V to 30 V	000 +- 40500		0.4	1.3	A	
Input bias-current change	I _O = 5 mA to 1 A	0°C to 125°C		0.03	0.5	mA mA	
Short-circuit output current		25°C		350		mA	
Peak output current		25°C		2.2		Α	

⁽¹⁾ Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.22-μF capacitor across the output.

Electrical Characteristics

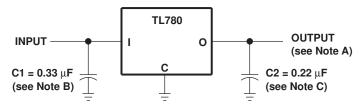
at specified virtual junction temperature, $V_1 = 23 \text{ V}$, $I_0 = 500 \text{ mA}$ (unless otherwise noted)

DADAMETER	TEST CONDITIONS	T (1)	Т	L780-15C		UNIT
PARAMETER	TEST CONDITIONS	T _J ⁽¹⁾	MIN	TYP	MAX	UNII
Output valtage	$I_{O} = 5 \text{ mA to 1 A, P} \le 15 \text{ W,}$	25°C	14.85	15	15.15	V
Output voltage	$V_1 = 17.5 \text{ V to } 30 \text{ V}$	0°C to 125°C	14.7		15.3	V
legut valtage regulation	V _I = 17.5 V to 30 V	25°C		1.5	15	mV
Input voltage regulation	V _I = 20 V to 26 V	25°C		1.5	15	IIIV
Ripple rejection	V _I = 18.5 V to 28.5 V, f = 120 Hz	0°C to 125°C	60	75		dB
Output voltage regulation	I _O = 5 mA to 1.5 A	25°C		7	75	mV
Output voltage regulation	I _O = 250 mA to 750 mA	25°C		2.5	45	IIIV
Output resistance	f = 1 kHz	0°C to 125°C		0.0035		Ω
Temperature coefficient of output voltage	I _O = 5 mA	0°C to 125°C		0.62		mV/°C
Output noise voltage	f = 10 Hz to 100 kHz	25°C		225		μV
Dropout voltage	I _O = 1 A	25°C		2		V
Input bias current		25°C		5.5	8	mA
land him administration	V _I = 17.5 V to 30 V	000 +- 40500		0.4	1.3	A
Input bias-current change	I _O = 5 mA to 1 A	0°C to 125°C		0.02	0.5	mA
Short-circuit output current		25°C		230		mA
Peak output current		25°C		2.2		Α

⁽¹⁾ Pulse-testing techniques maintain the junction temperature as close to the ambient temperature as possible. Thermal effects must be taken into account separately. All characteristics are measured with a 0.33-μF capacitor across the input and a 0.22-μF capacitor across the output.



PARAMETER MEASUREMENT INFORMATION



- A. Permanent damage can occur when OUTPUT is pulled below ground.
- B. C1 is required when the regulator is far from the power-supply filter.
- C. C2 is not required for stability; however, transient response is improved.

Figure 1. Test Circuit



APPLICATION INFORMATION



Figure 2. Positive Regulator in Negative Configuration (V_I Must Float)

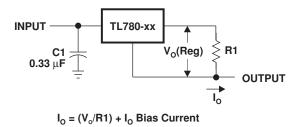


Figure 3. Current Regulator

Operation With a Load Common to a Voltage of Opposite Polarity

In many cases, a regulator powers a load that is not connected to ground, but instead, is connected to a voltage source of opposite polarity (e.g., operational amplifiers, level-shifting circuits, etc.). In these cases, a clamp diode should be connected to the regulator output as shown in Figure 4. This protects the regulator from output polarity reversals during startup and short-circuit operation.

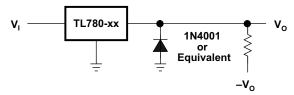


Figure 4. Output Polarity-Reversal-Protection Circuit

Reverse-Bias Protection

Occasionally, the input voltage to the regulator can collapse faster than the output voltage. This, for example, could occur when the input supply is crowbarred during an output overvoltage condition. If the output voltage is greater than approximately 7 V, the emitter-base junction of the series pass element (internal or external) could break down and be damaged. To prevent this, a diode shunt can be employed, as shown in Figure 5.

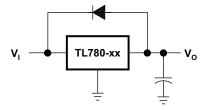


Figure 5. Reverse-Bias-Protection Circuit

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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
TL780-05CKTTR	LIFEBUY	DDPAK/ TO-263	KTT	3	500	RoHS & Green	(6) SN	Level-3-245C-168 HR	0 to 125	TL780-05C	
TL780-05CKTTRG3	LIFEBUY	DDPAK/ TO-263	KTT	3	500	RoHS & Green	SN	Level-3-245C-168 HR	0 to 125	TL780-05C	
TL780-05KCS	ACTIVE	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	0 to 125	TL780-05	Samples
TL780-05KCSE3	ACTIVE	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	0 to 125	TL780-05	Samples
TL780-12KCS	ACTIVE	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	0 to 125	TL780-12	Samples
TL780-15KCS	ACTIVE	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	0 to 125	TL780-15	Samples
TL780-15KCSE3	ACTIVE	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	0 to 125	TL780-15	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.



PACKAGE OPTION ADDENDUM

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(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

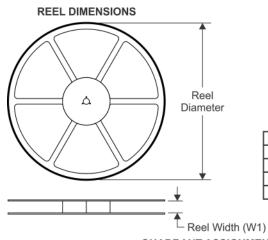
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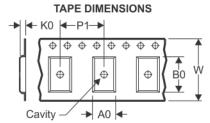
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PACKAGE MATERIALS INFORMATION

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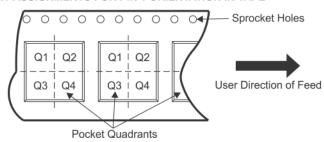
TAPE AND REEL INFORMATION





		Dimension designed to accommodate the component width
		Dimension designed to accommodate the component length
K	(0	Dimension designed to accommodate the component thickness
٧	Λ	Overall width of the carrier tape
F	21	Pitch between successive cavity centers

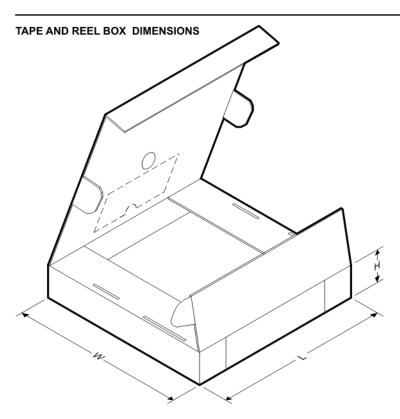
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL780-05CKTTR	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.8	16.3	5.11	16.0	24.0	Q2

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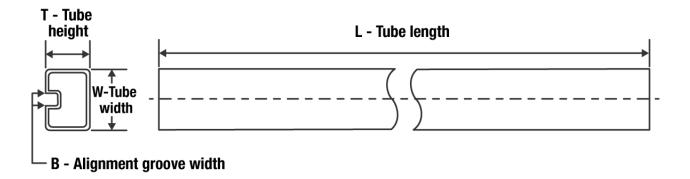
*All dimensions are nominal

ĺ	Device	Device Package Type		Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
I	TL780-05CKTTR	DDPAK/TO-263	KTT	3	500	340.0	340.0	38.0	

PACKAGE MATERIALS INFORMATION

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TUBE

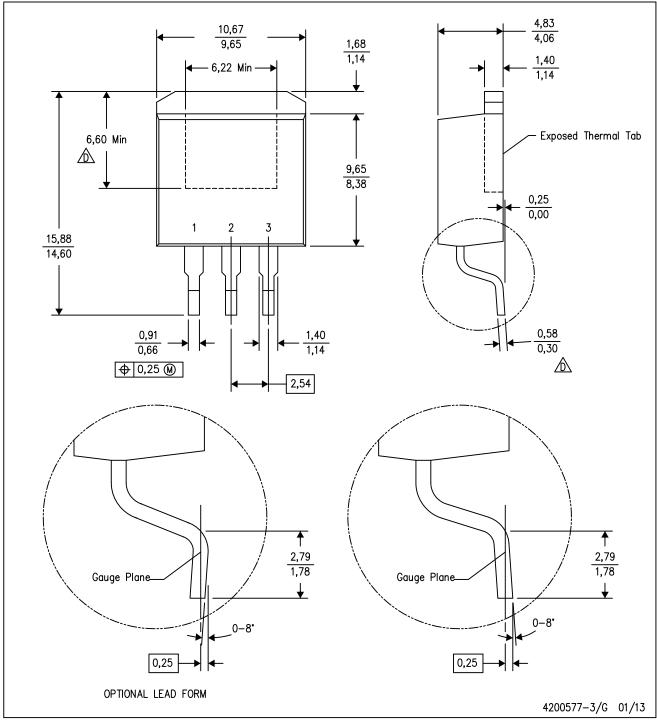


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
TL780-05KCS	KCS	TO-220	3	50	532	34.1	700	9.6
TL780-05KCSE3	KCS	TO-220	3	50	532	34.1	700	9.6
TL780-12KCS	KCS	TO-220	3	50	532	34.1	700	9.6
TL780-15KCS	KCS	TO-220	3	50	532	34.1	700	9.6
TL780-15KCSE3	KCS	TO-220	3	50	532	34.1	700	9.6

KTT (R-PSFM-G3)

PLASTIC FLANGE-MOUNT PACKAGE



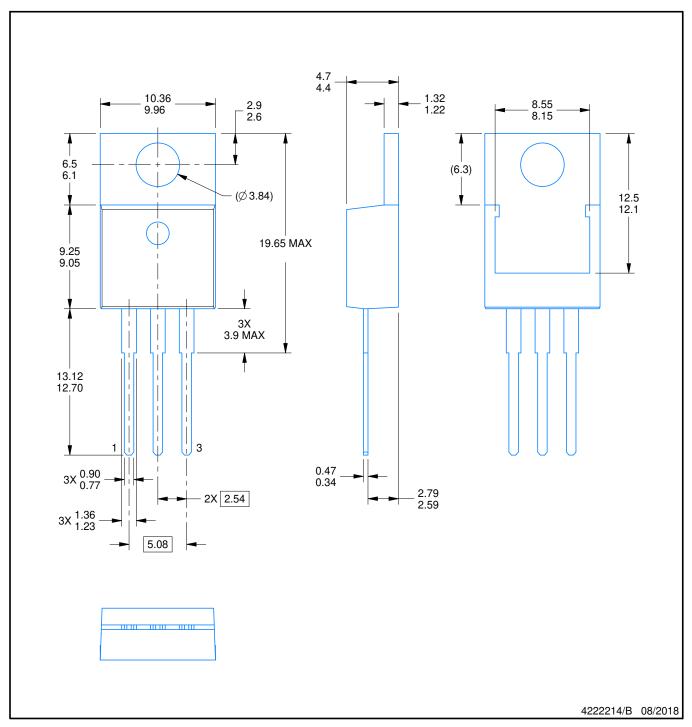
NOTES:

- A. All linear dimensions are in millimeters.
- 3. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
- ⚠ Falls within JEDEC T0—263 variation AA, except minimum lead thickness and minimum exposed pad length.





TO-220

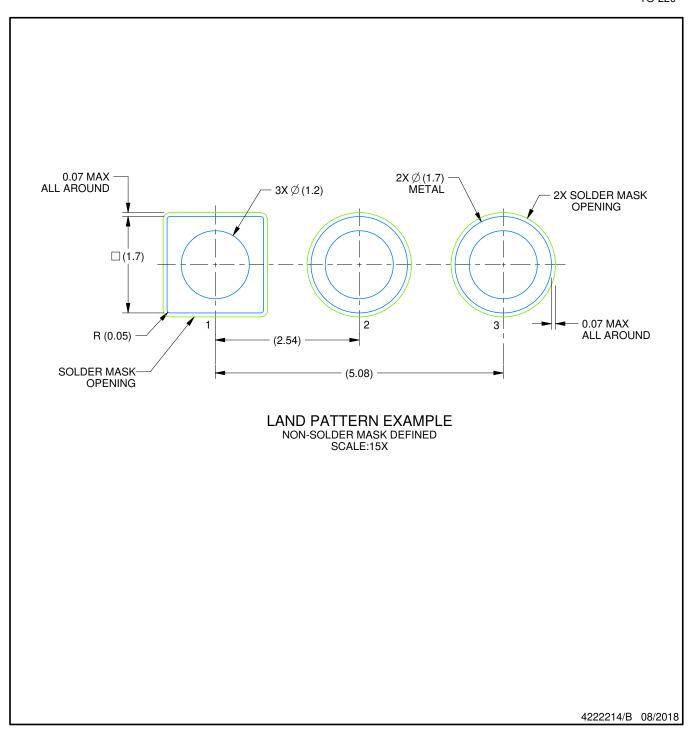


NOTES:

- Dimensions are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 Reference JEDEC registration TO-220.



TO-220



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